

# PARA LIGHT ELECTRONICS CO., LTD.

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# DATA SHEET

# PART NO. : EP505L-350B1

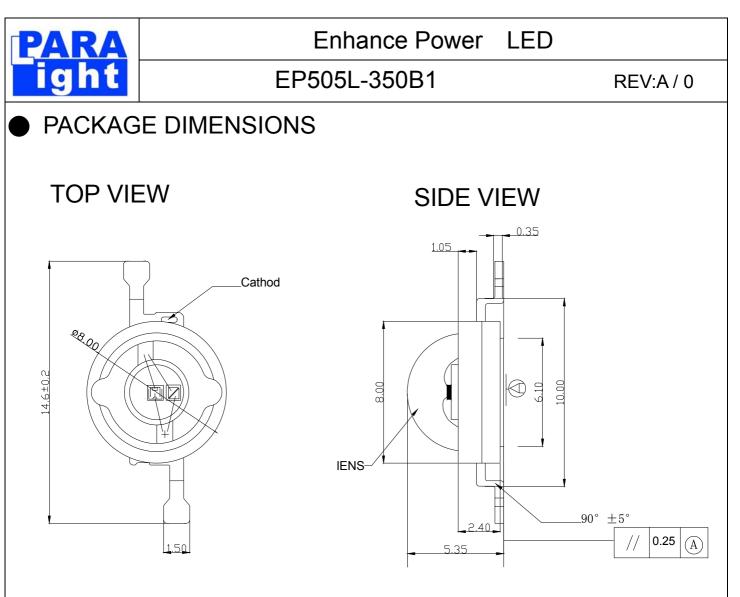
# REV: <u>A/0</u>

CUSTOMER'S APPROVAL :

DCC :

DRAWING NO. : DS-53-06-0005

DATE : 2006-09-29



#### Notes:

1. All dimensions are in millimeters.

2. Tolerance is  $\pm$  0.25mm (.020") unless otherwise

#### Features

- \* HIGHEST FLUX PER LED IN THE WORLD
- \* VERY LONG OPERATING LIFE
- \* MORE ENERGY EFFICIENT THAN INCANDESCENT AND MOST HALOGEN LAMPS
- \* LOW VOLTAGE DC OPERATED
- \* COOL BEAM SAFE TO THE TOUCH
- \* INSTANT LIGHT (LESS THAN 100NS)
- \* NO UV

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Enhance Power LED

### EP505L-350B1

REV:A/0

## Chip Materials

- \* Dice Material : InGaN
- \* Light Color : BLUE
- \* Lens Color : Water Clear

# ● Absolute Maximum Ratings(Ta=25°C)

Symbol	Parameter	Rating	Unit	
lF	DC Forward Current	350	mA	
lauta a	Peak pulse current;	500	mA	
Ipulse	(tp $\leq$ 100us, Duty cycle=0.25)	500		
VR	Reverse Voltage	5	V	
lr	Reverse Current(Vr=5V)	50	uA	
Tj	LED junction Temperature(at 350mA)	125	°C	
*Topr	Operating Temperature	-30 ~ +100	°C	
*Tstg	Storage Temperature	-40 ~ +100	°C	
Tsol	Manual Soldering Time at 260 $^\circ C$ (Max.)	5	seconds	

Note:

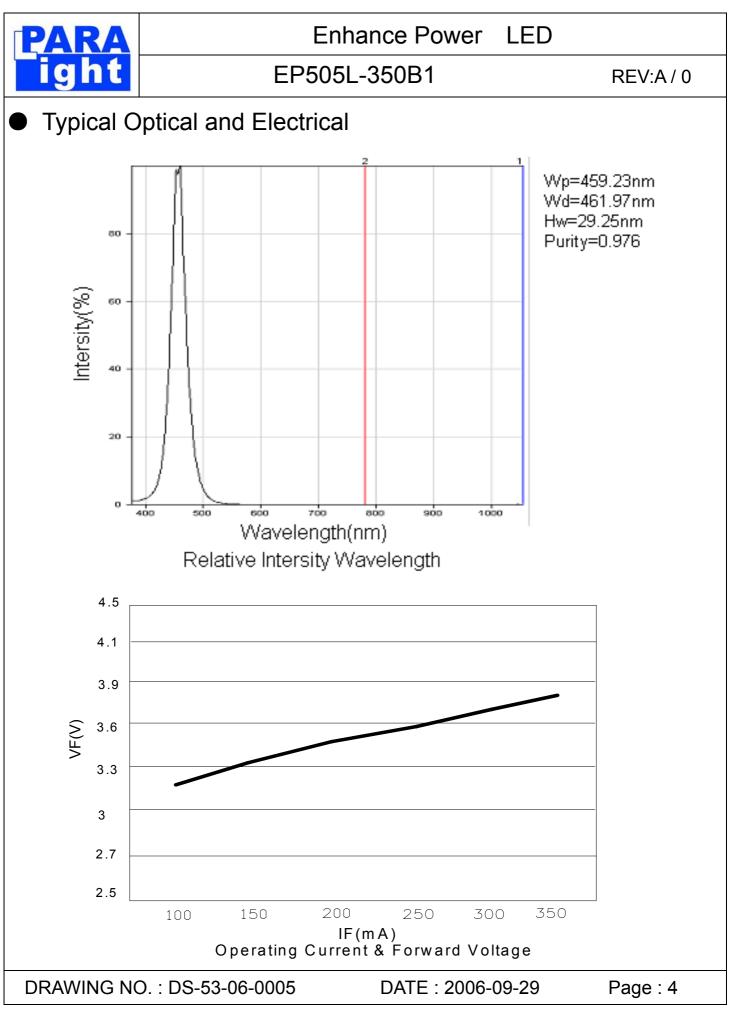
- \* : Temperature for using with aluminum board.
- HBM : Human Body Model. Seller gives no other assurances regarding the ability of to withstand ESD.

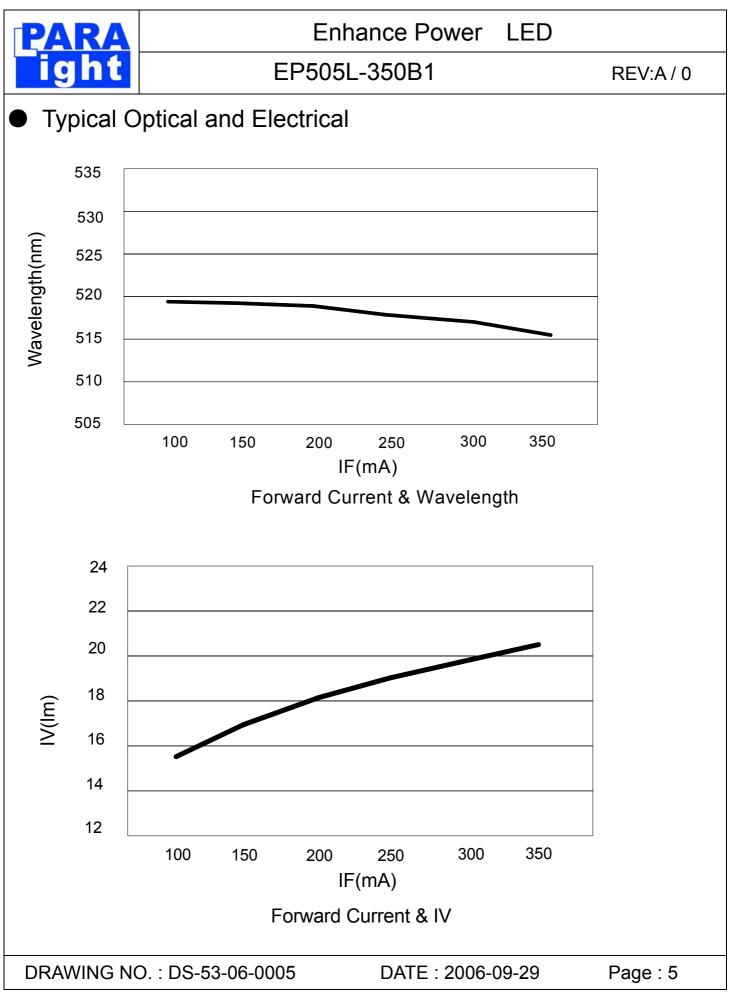
# Electro-Optical Characteristics(Ta=25°C)

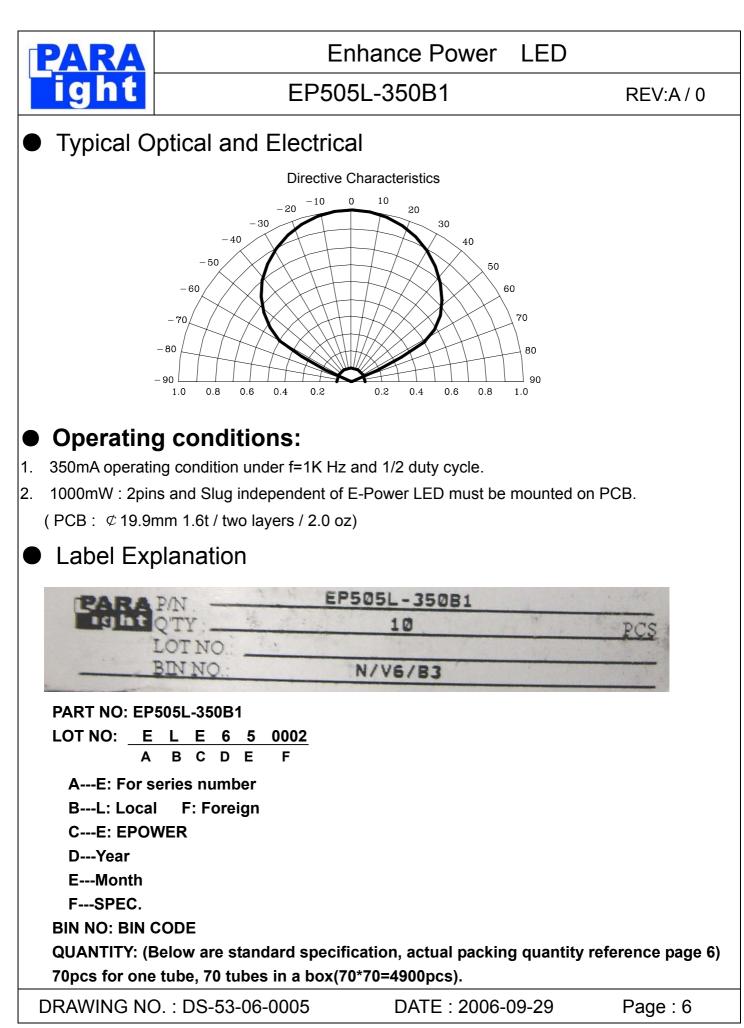
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test Condition
Luminous Intensity	IV	7.79	16		lm	IF=350mA/100ms
Viewing Angle	<b>2</b> θ <b>1/2</b>		130		deg	Note 2
Peak Emission	) n		453		nm	Measurement
Wavelength	λp		455		nm	@Peak
Dominant Wavelength	λd		460		nm	IF=350mA
Spectral Line	Λλ		30		22	
Half-Width			30		nm	
Forward Voltage	VF	3.23	4.2	5.06	V	IF =350mA
Reverse Current	IR			100	μ Α	VR = 5V

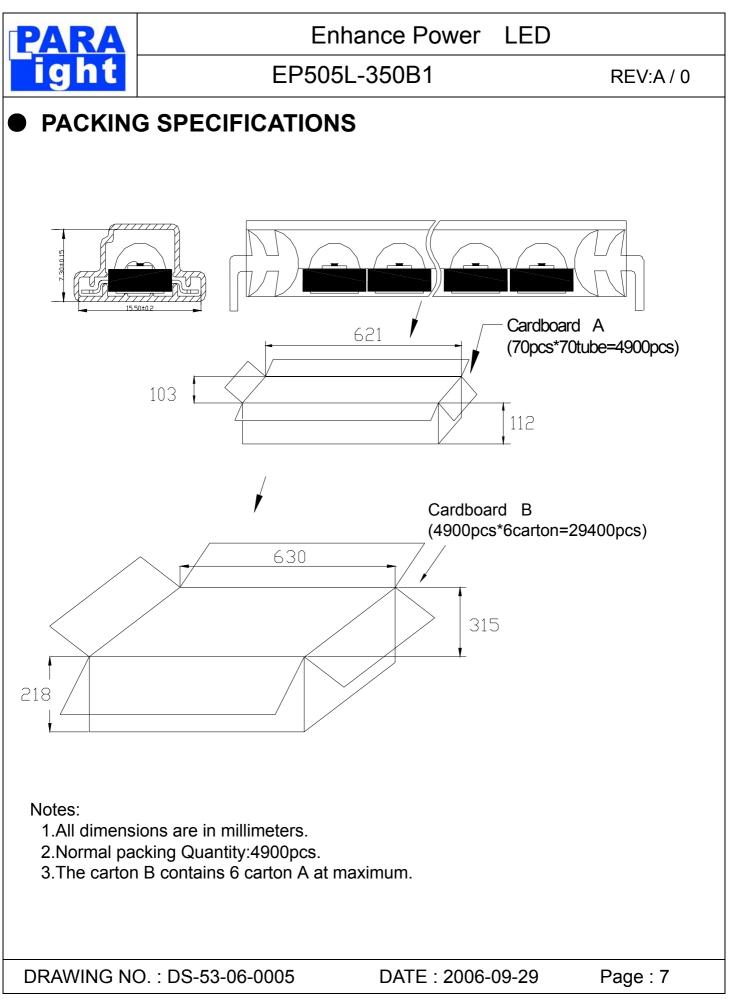
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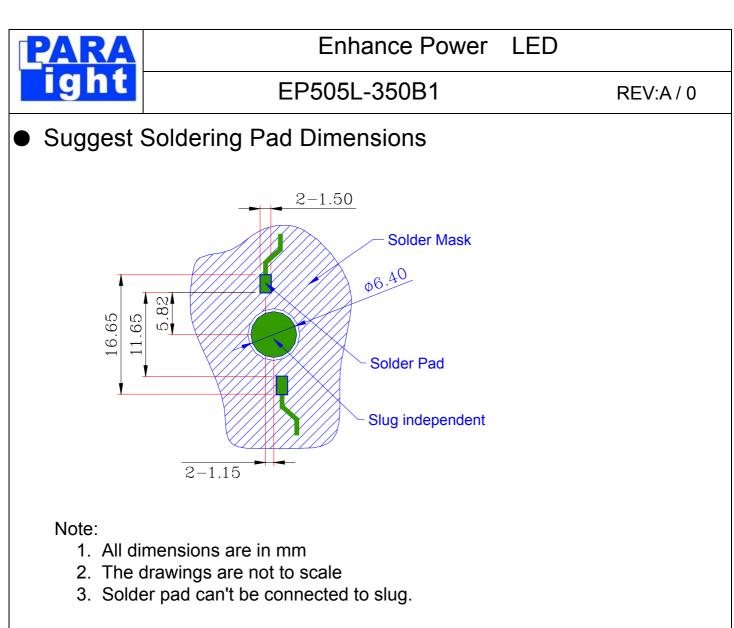
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## Bin Code List

Luminous Intensity(IV), Unit:Im@350mA				
Bin Code	Min	Max		
R	7.79	12.37		
S	10.12	16.08		
Т	13.16	20.91		
U	17.10	27.18		

Forward Voltage(VF), Unit:V@350mA				
Bin Code	Min	Max		
V5	3.23	4.60		
V6	3.40	4.83		
V7	3.57	5.06		

#### Including test tolerance

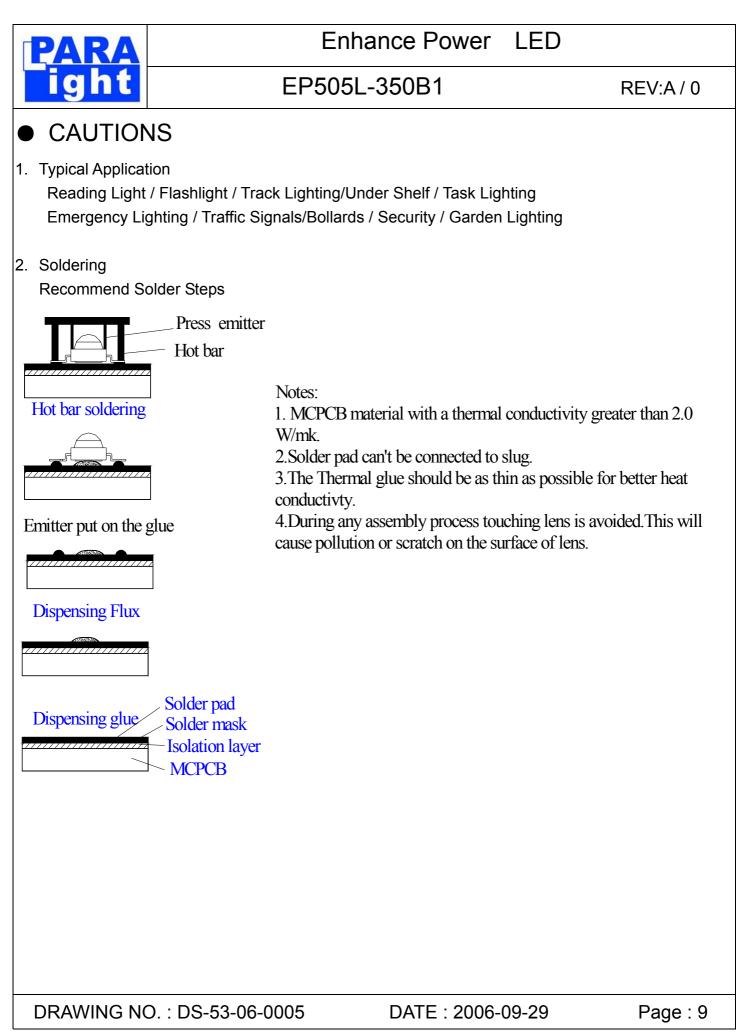
Including test tolerance

Dom	Dominant Wavelength (Hue),Unit: nm@350mA			
Bin Code	Min	Max		
B2	449	456		
B3	454	461		
B4	459	466		

Including  $\pm$  1nm test tolerance

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HD-R/RD012





### EP505L-350B1

## • E-POWER OPERATING PROCEDURE

1. E-power 350 series should be operated at 350 mA for ideal performance, but not more than 360mA.

- 2. Ep5 can't be soldered with solder paste using reflow process. The suggested soldering temperature in the data sheet.
- 3. Blue, Cyan, Green and White colors must be used in conjunction with heat-sinking devices. Soldering on AI PCB with mid-connection point while keeping the layout pattern (⊄ 19.9mm)is another way to help heat dissipation. Thermal Resistance for aluminum board must be less than 0.65 °C/W.
- 4. Please be aware that the mid-connection point for Red and Amber is negative-polarity while it is non-polarity in Blue, Cyan, Green and White.
- 5. E-power products are sensitive to static, especially in Blue, Cyan, Green . Operators must wear static wristband (wireless static wristband is prohibited) and be well grounded while working in the environment with an ionizing air blower. Anti-static requirement should be under ESD 400V.
- 6. E-power products are fully tested and shipped in anti-static packaging.
- 7. A non-conductive heat-dissipating paste should be applied between E-power and heat-sinking device.
- 8. It is recommended to design circuit in series with protected IC to limit current flow. In a parallel connection, each IC should be protected individually.



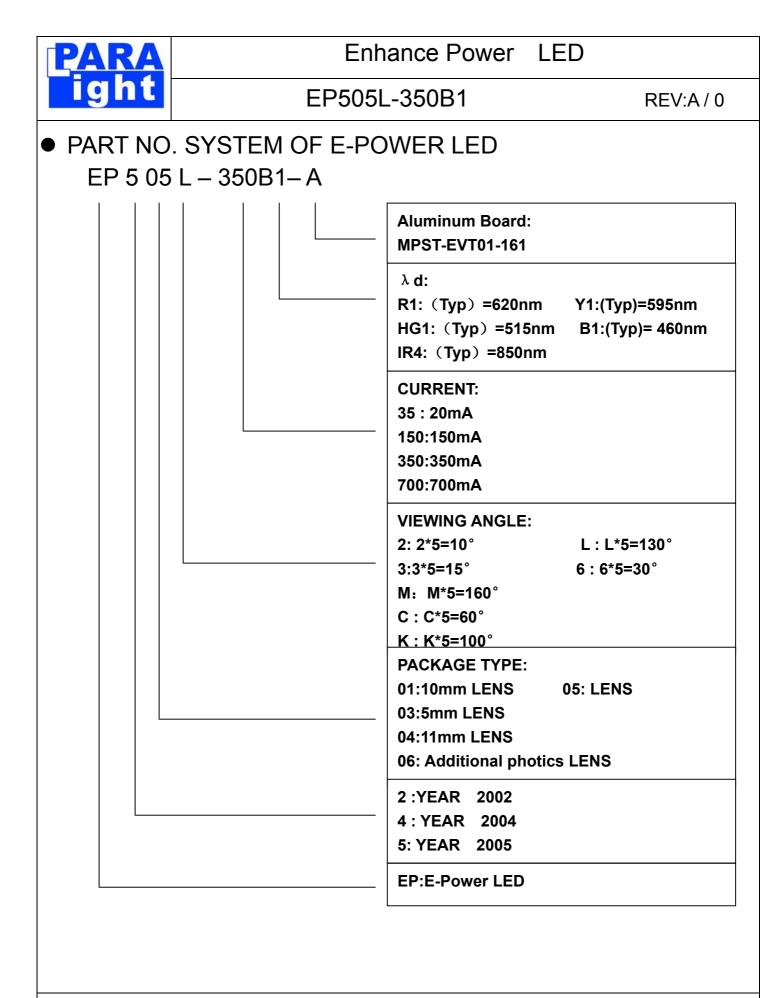


REV:A/0

# Reliability Test

Classification	Test Item	em Test Condition Reference Standard		Units Tested	Units Failed
	High Temperature High Humidity Storage 1	In-Board, 1 Times Ta= 85±5℃,RH= 90~95% Current =45mA *Test Time= 1000HRS±2HRS		22	0
Endurance	High Temperature High Humidity Storage 2	In-Board, 1 Times Ta= 85±5℃,RH= 90~95% Reverse Voltage=5V *Test Time= 1000HRS±2HRS		22	0
Test	Life test 1	Ta= 55±5℃ Current =70mA *Test Time=1000HRS		22	0
	Life test 2	Ta= -40±5℃ Current =70mA *Test Time=1000HRS		22	0
Environmental Test	Temperature Cycling 1	In-Board, 1 Times 100±5℃ -55±5℃ 15mins DWELL 5nin 20 Cycles 100 Cycles	MIL-STD-883 METHOD 1010	22	0
	Temperature Cycling 2	In-Board, 1 Times 120±5℃ -40±5℃ 15mins DWELL 5nin 20 Cycles 100 Cycles	MIL-STD-883 METHOD 1010	22	0

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